

50V N-Channel Enhancement Mode MOSFET - ESD Protected

Voltage 50 V Current 360mA

Features

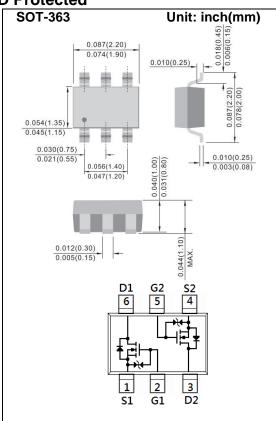
- $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@500mA<1.6\Omega$
- $R_{DS(ON)}$, $V_{GS}@4.5V$, $I_D@200mA<2.5\Omega$
- R_{DS(ON)}, V_{GS}@2.5V, I_D@100mA<4.5Ω
- Advanced Trench Process Technology
- Specially Designed for Battery Operated Systems, Solid-State Relays Drivers: Relay, Displays, Memories, etc
- ESD Protected 2KV HBM
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: SOT-363 Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0002 ounces, 0.006 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETE	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage	V _{DS}	50			
Gate-Source Voltage	V _{GS}	<u>+</u> 20	V		
Continuous Drain Current (Note 4)	I _D	360	mA		
Pulsed Drain Current (Note 1)		I _{DM}			1200
Power Dissipation	T _A =25°C	_	236	mW	
	Derate above 25°C	P _D	1.89	mW/°C	
Operating Junction and Storage Temperature Range		T_{J},T_{STG}	-55~150	°C	
Typical Thermal Resistance - Junction to Ambient (Note 3,4)		RөJA	530	°C/W	



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	50	-	-	V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250uA$	0.8	1	1.5	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =500mA	-	0.96	1.6	Ω	
		V _{GS} =4.5V, I _D =200mA	-	1.25	2.5		
		V _{GS} =2.5V, I _D =100mA	-	2.73	4.5		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =50V, V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	Igss	V _{GS} = <u>+</u> 20V, V _{DS} =0V	-	-	<u>+</u> 10	uA	
Dynamic							
Total Gate Charge	Qg	\/ O5\/ O50 \	-	0.63	1	nC	
Gate-Source Charge	Q _{gs}	V_{DS} =25V, I_{D} =250mA, V_{GS} =4.5V (Note 1,2)	-	0.2	-		
Gate-Drain Charge	Q_{gd}	VGS=4.5V (************************************	-	0.23	-		
Input Capacitance	Ciss), OF),), O),	-	25	50	pF	
Output Capacitance	Coss	V _{DS} =25V, V _{GS} =0V, f=1MHZ	-	9.5	20		
Reverse Transfer Capacitance	Crss	I= IIVII IZ	-	2.1	5		
Turn-On Delay Time	td _(on)	.,	-	2.2	5		
Turn-On Rise Time	tr	V _{DD} =25V, I _D =500mA,	-	19.2	38	ns	
Turn-Off Delay Time	td _(off)	$V_{GS}=10V$, $R_{G}=6\Omega$ (Note 1,2)	-	6.2	12		
Turn-Off Fall Time	tf	NG-012 (*** / /	-	23	50		
Drain-Source Diode							
Maximum Continuous Drain-Source Diode Forward Current	Is		-	-	500	mA	
Diode Forward Voltage	V _{SD}	I _S =500mA, V _{GS} =0V	-	0.86	1.5	V	

NOTES:

- 1. Pulse width < 300us, Duty cycle < 2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. R_{OJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

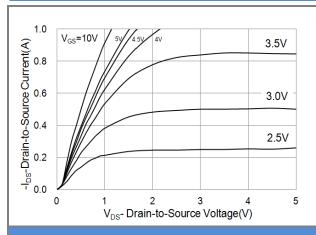


Fig.1 On-Region Characteristics

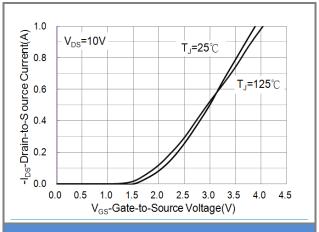


Fig.2 Transfer Characteristics

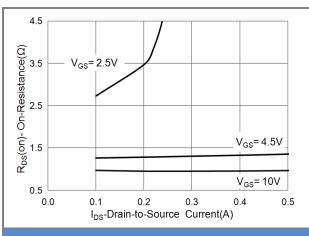


Fig.3 On-Resistance vs. Drain Current

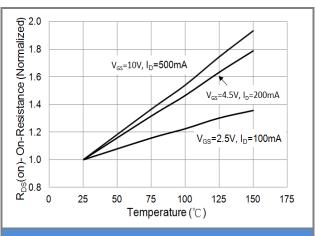
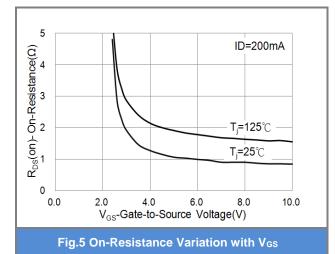
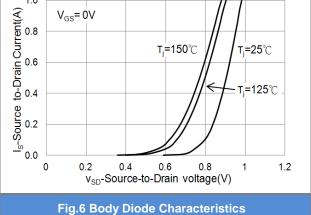


Fig.4 On-Resistance vs. Junction temperature







TYPICAL CHARACTERISTIC CURVES

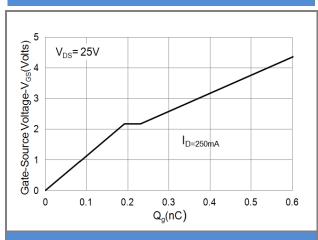


Fig.7 Gate-Charge Characteristics

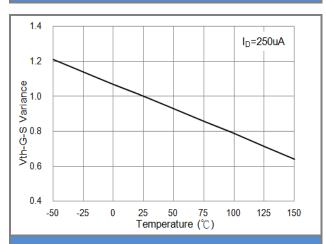


Fig.9 Threshold Voltage Variation with Temperature

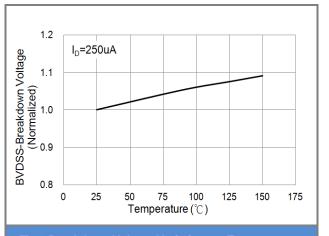


Fig.8 Breakdown Voltage Variation vs. Temperature

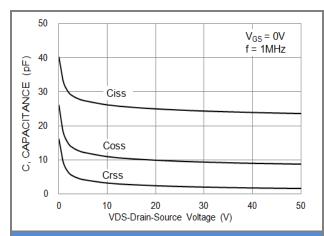


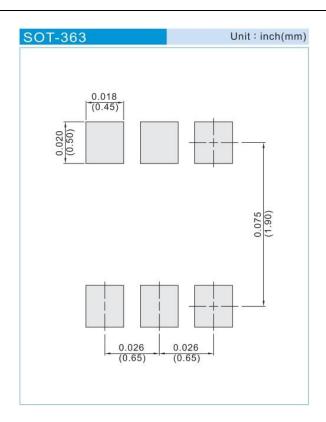
Fig.10 Capacitance vs. Drain-Source Voltage



Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJT138K-AU	SOT-363	3K pcs / 7" reel	8KD

Mounting Pad Layout





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